

IN THE SPECIFICATION:

Please revise the specification as follows:

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Fig. 16 depicts a modular system in which a plurality of modules capacitively couple to a backplane;

H¹ Figs. 17A-B comparatively depict connection methods in accordance with the prior art and the present invention;

Figs. 18A-C depict several steps in the assembly of an MCM (such as those of Figs. 4-5) in accordance with the invention;